

LOCTITE ABLESTIK CE 3103

December 2016

PRODUCT DESCRIPTION

LOCTITE ABLESTIK CE 3103 provides the following product characteristics:

Technology	Ероху
Appearance	Silver
Filler Type	Silver
Filler Weight, %	75
Product Benefits	One component
	 Electrically conductive
	 Pb-free alternative to solder
	Low CTE
	 Low cure temperature
	Exceptional thermo-mechanical junction reliability
Cure	Heat cure
Operating Temperature	150 °C
Application	Electrically Conductive Adhesive
Typical Package	SMD component attach
Application	
Substrates	Sn, Sn/Pb and OSP-Cu printed circuit boards

LOCTITE ABLESTIK CE 3103 adhesive is a lead-free alternative to solder. It is highly compatible with existing SMT assembly processes and can be applied by syringe dispense or printing.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity @ 25 °C, mPa·s (cP)	50,000
Specific Gravity	3.5
Work Life @ 24°C, hours	24
Shelf Life @ -40°C, days	183
Flash Point - See SDS	

TYPICAL CURING PERFORMANCE Cure Schedule

Reflow: 3 minutes @ 150°C or 5 minutes @ 125°C Convection: 8 minutes @ 125°C or 5 minutes @ 150°C

NOTE:LOCTITE ABLESTIK CE 3103 cures completely during a typical reflow cycle and does not require postcure operation.

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties:

Coefficient of Thermal Expansion ppm/°C: Below Tg Above Tg		45 146			
Glass Transition Temperature (Tg), °C		109			
Tensile Modulus, DMTA:					
@ 25 °C		5,600 (812,000)			
@ 150 °C	N/mm² (psi)	200 (29,000)			
Extractable Ionic Content, ppm:					
Chloride (Cl-)	<50				
Sodium (Na+)		<10			
Potassium (K+)		<5			
Electrical Properties:					
Volume Resistivity @ 25°C, ohm-cm		0.0007			

TYPICAL PERFORMANCE OF CURED MATERIAL

Tensile Lap Shear Strength, MPa 8



PERFORMANCE AND RELIABILITY DATA

Contact resistance stability has been evaluated using a 6 mil (150µm) print on a daisy chain pattern without resistors (with 10 resistor positions).

Initial Contact Resistance:

Chain Average:					
OSP coated Cu, ohm	0.139				
SnPb, ohm	0.3283				
Sn, ohm	0.5152				
Individual Pad:					
OSP coated Cu, ohm	0.0069				
SnPb, ohm	0.0164				
Sn, ohm	0.0258				

% Change from Initial Reading:

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5	00 hours, 85°C / 85% RH:			
	OSP coated Cu, %	8		
	SnPb, %	4		
	Sn, %	-53		
1,000 hours, 85°C / 85% RH:				
	OSP coated Cu, %	9		
	SnPb, %	47		
	Sn, %	-68		

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

THAWING:

1. Allow container to reach room temperature before use.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 to -35°C. Storage below -40°C can adversely affect product properties (freeze-thaw voids).

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

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